General Purpose Transistors

PNP Silicon

Features

• Pb-Free Packages are Available*

MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector – Emitter Voltage	V _{CEO}	40	Vdc
Collector – Base Voltage	V _{CBO}	40	Vdc
Emitter – Base Voltage	V _{EBO}	5.0	Vdc
Collector Current – Continuous	Ι _C	200	mAdc
Total Device Dissipation @ T _A = 25°C Derate above 25°C	P _D	625 5.0	mW mW/°C
Total Power Dissipation @ $T_A = 60^{\circ}C$	PD	250	mW
Total Device Dissipation @ T _C = 25°C Derate above 25°C	P _D	1.5 12	W mW/°C
Operating and Storage Junction Temperature Range	T _J , T _{stg}	-55 to +150	°C

THERMAL CHARACTERISTICS (Note 1)

Characteristic	Symbol	Мах	Unit
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	200	°C/W
Thermal Resistance, Junction-to-Case	$R_{\theta JC}$	83.3	°C/W

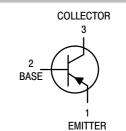
Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

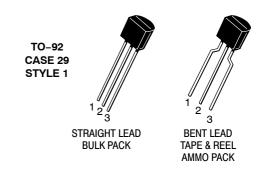
1. Indicates Data in addition to JEDEC Requirements.



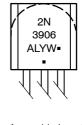
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MARKING DIAGRAM



A = Assembly Location L = Wafer Lot

- Y = Year
- W = Work Week
- = Pb-Free Package

(Note: Microdot may be in either location)

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 3 of this data sheet.

*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

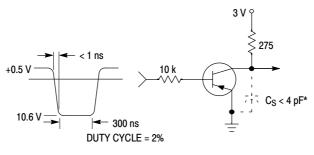
ELECTRICAL CHARACTERISTICS ($T_A = 25^{\circ}C$ unless otherwise noted)

Characteristic			Symbol	Min	Max	Unit
OFF CHARACTERIST	rics	·		•	•	
Collector - Emitter Bre	akdown Voltage (l	Note 2) (I _C = 1.0 mAdc, I _B = 0)	V _{(BR)CEO}	40	-	Vdc
Collector - Base Break	down Voltage	$(I_{C} = 10 \ \mu Adc, I_{E} = 0)$	V _{(BR)CBO}	40	-	Vdc
Emitter-Base Breakd	own Voltage	(I _E = 10 μAdc, I _C = 0)	V _{(BR)EBO}	5.0	-	Vdc
Base Cutoff Current		(V _{CE} = 30 Vdc, V _{EB} = 3.0 Vdc)	I _{BL}	-	50	nAdc
Collector Cutoff Curre	nt	$(V_{CE} = 30 \text{ Vdc}, V_{EB} = 3.0 \text{ Vdc})$	I _{CEX}	-	50	nAdc
ON CHARACTERISTI	CS (Note 2)					÷
DC Current Gain			h _{FE}	60 80 100 60 30	_ 300 _ _	_
Collector – Emitter Sat	uration Voltage	$(I_{C} = 10 \text{ mAdc}, I_{B} = 1.0 \text{ mAdc})$ $(I_{C} = 50 \text{ mAdc}, I_{B} = 5.0 \text{ mAdc})$	V _{CE(sat)}	_ _	0.25 0.4	Vdc
Base – Emitter Saturat	ion Voltage	$(I_{C} = 10 \text{ mAdc}, I_{B} = 1.0 \text{ mAdc})$ $(I_{C} = 50 \text{ mAdc}, I_{B} = 5.0 \text{ mAdc})$	V _{BE(sat)}	0.65 -	0.85 0.95	Vdc
SMALL-SIGNAL CH	ARACTERISTICS					
Current-Gain - Band	width Product	$(I_C = 10 \text{ mAdc}, V_{CE} = 20 \text{ Vdc}, f = 100 \text{ MHz})$	f _T	250	-	MHz
Output Capacitance		$(V_{CB} = 5.0 \text{ Vdc}, I_E = 0, f = 1.0 \text{ MHz})$	C _{obo}	-	4.5	pF
Input Capacitance		$(V_{EB} = 0.5 \text{ Vdc}, I_{C} = 0, f = 1.0 \text{ MHz})$	C _{ibo}	-	10	pF
Input Impedance		$(I_{C} = 1.0 \text{ mAdc}, V_{CE} = 10 \text{ Vdc}, f = 1.0 \text{ kHz})$	h _{ie}	2.0	12	kΩ
Voltage Feedback Rat	io	$(I_{C} = 1.0 \text{ mAdc}, V_{CE} = 10 \text{ Vdc}, f = 1.0 \text{ kHz})$	h _{re}	0.1	10	X 10 ⁻⁴
Small-Signal Current	Gain	(I _C = 1.0 mAdc, V _{CE} = 10 Vdc, f = 1.0 kHz)	h _{fe}	100	400	-
Output Admittance		(I _C = 1.0 mAdc, V _{CE} = 10 Vdc, f = 1.0 kHz)	h _{oe}	3.0	60	μmhos
Noise Figure $(I_C = 100 \ \mu Adc, V_{CE} = 5.0 \ Vdc, R_S = 1.0 \ k\Omega, f = 1.0 \ kHz)$		NF	-	4.0	dB	
SWITCHING CHARAG	CTERISTICS					
Delay Time	(V _{CC} = 3.0 Vdc,	V _{BF} = 0.5 Vdc,	t _d	-	35	ns
Rise Time	$I_{\rm C} = 10 \rm mAdc, I_{\rm E}$		t _r	-	35	ns
Storage Time	(V _{CC} = 3.0 Vdc,	$I_{\rm C}$ = 10 mAdc, $I_{\rm B1}$ = $I_{\rm B2}$ = 1.0 mAdc)	t _s	-	225	ns
Fall Time	(V _{CC} = 3.0 Vdc,	I _C = 10 mAdc, I _{B1} = I _{B2} = 1.0 mAdc)	t _f	-	75	ns

ORDERING INFORMATION

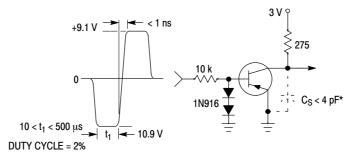
Device	Package	Shipping [†]	
2N3906	TO-92	5000 Units / Bulk	
2N3906G	TO-92 (Pb-Free)	5000 Units / Bulk	
2N3906RL1	TO-92	2000 / Tape & Reel	
2N3906RL1G	TO-92 (Pb-Free)	2000 / Tape & Reel	
2N3906RLRA	TO-92	2000 / Tape & Reel	
2N3906RLRAG	TO-92 (Pb-Free)	2000 / Tape & Reel	
2N3906RLRM	TO-92	2000 / Tape & Ammo Box	
2N3906RLRMG	TO-92 (Pb-Free)	2000 / Tape & Ammo Box	
2N3906RLRP	TO-92	2000 / Tape & Ammo Box	
2N3906RLRPG	TO-92 (Pb-Free)	2000 / Tape & Ammo Box	

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.



* Total shunt capacitance of test jig and connectors

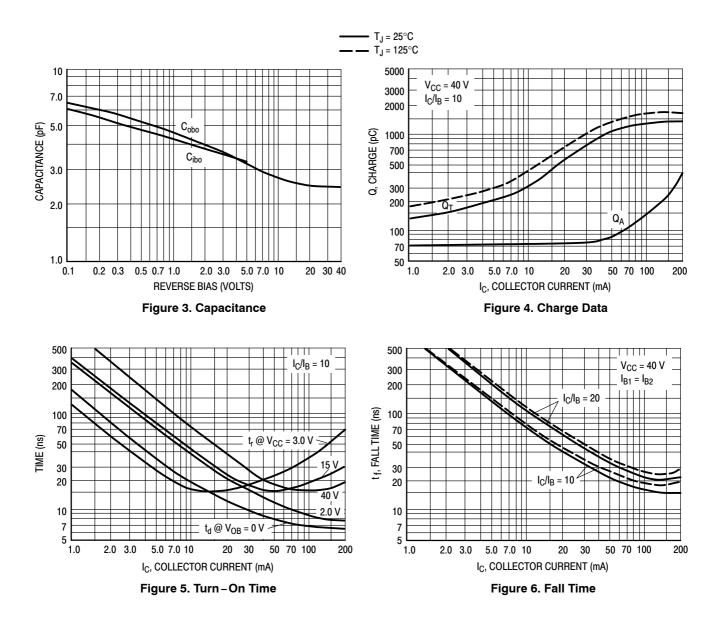
Figure 1. Delay and Rise Time Equivalent Test Circuit



* Total shunt capacitance of test jig and connectors

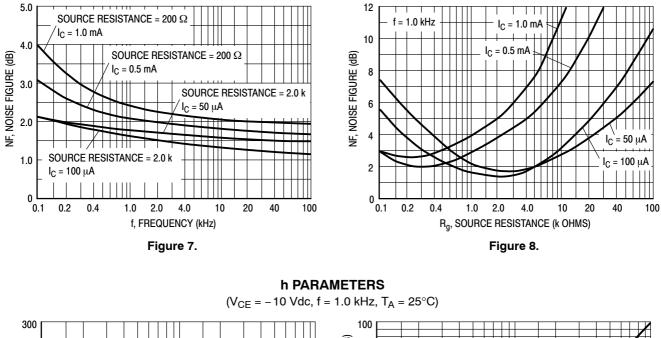
Figure 2. Storage and Fall Time Equivalent Test Circuit

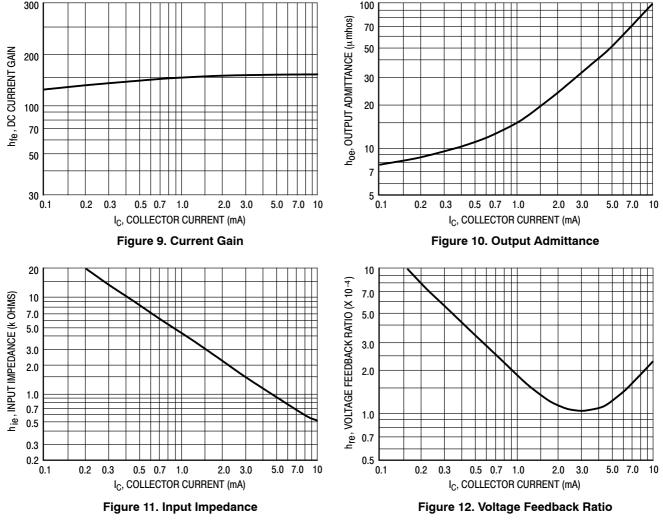
TYPICAL TRANSIENT CHARACTERISTICS



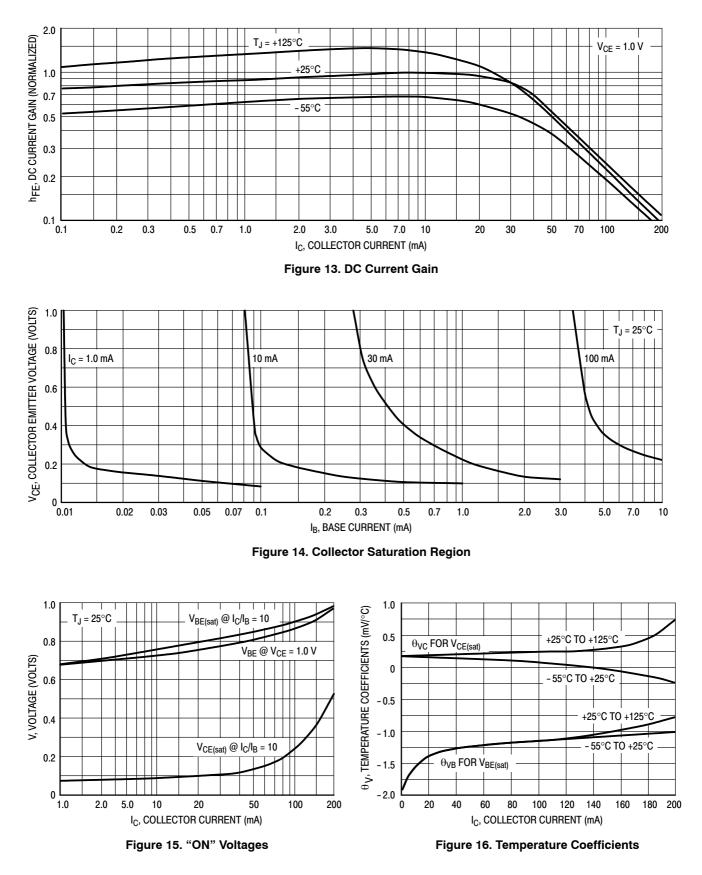
TYPICAL AUDIO SMALL-SIGNAL CHARACTERISTICS NOISE FIGURE VARIATIONS

(V_{CE} = -5.0 Vdc, T_A = 25° C, Bandwidth = 1.0 Hz)





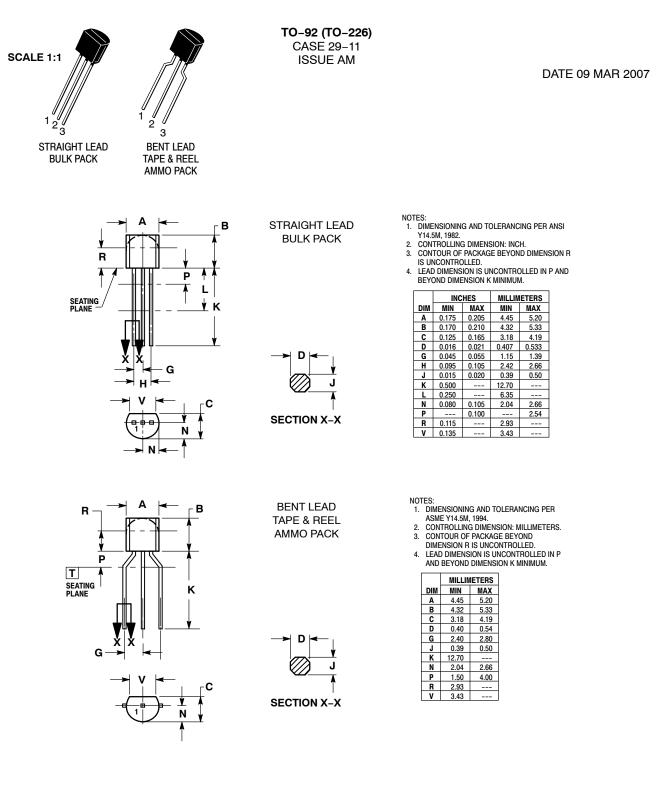
TYPICAL STATIC CHARACTERISTICS



MECHANICAL CASE OUTLINE PACKAGE DIMENSIONS

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STYLES ON PAGE 2

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STYLE 1: PIN 1. EMITTER 2. BASE 3. COLLECTOR STYLE 6: PIN 1. GATE 2. SOURCE & SUBSTRATE 3. DRAIN STYLE 11: PIN 1. ANODE 2. CATHODE & ANODE 3. CATHODE STYLE 16: PIN 1. ANODE 2. GATHODE STYLE 16: PIN 1. COLLECTOR 2. EMITTER 3. GATHODE STYLE 21: PIN 1. VCC 2. GROUND 2 3. OUTPUT STYLE 31: PIN 1. GATE 2. DRAIN 3. SOURCE

	BASE EMITTER COLLECTOR
2.	Source Drain Gate
2.	MAIN TERMINAL 1 Gate Main Terminal 2
2.	COLLECTOR BASE EMITTER
2.	SOURCE GATE DRAIN

2.	ANODE ANODE CATHODE
	DRAIN GATE SOURCE & SUBSTRATE
2.	ANODE 1 GATE CATHODE 2
2.	ANODE CATHODE NOT CONNECTED
	GATE SOURCE DRAIN
2.	CATHODE ANODE GATE
STYLE 33: PIN 1. 2.	RETURN

3. OUTPUT

2.	CATHODE CATHODE ANODE
2.	BASE 1 EMITTER BASE 2
2.	EMITTER COLLECTOR BASE
	GATE ANODE CATHODE
2.	EMITTER COLLECTOR/ANODE CATHODE
2.	NOT CONNECTED ANODE CATHODE

STYLE 5: PIN 1. DRAIN 2. SOURCE 3. GATE 2. GATE 2. GATE 3. ANODE STYLE 15: PIN 1. CATHODE 2. CATHODE 3. ANODE 2 STYLE 20: PIN 1. NOT CONNECTED 2. CATHODE 3. ANODE STYLE 25: PIN 1. MT 1 2. GATE 3. MT 2 STYLE 30: PIN 1. DRAIN 2. GATE 3. SOURCE STYLE 35: PIN 1. GATE 3. SOURCE STYLE 35: PIN 1. GATE 3. EMITTER

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